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PIC18F87J93 FAMILY

64/80-Pin, High-Performance Microcontrollers with LCD Driver, 12-Bit A/D and nanoWatt Technology

LCD Driver and Keypad Interface Features:

- Direct LCD Panel Drive Capability:
  - Can drive LCD panel while in Sleep mode
- Up to 48 Segments and 192 Pixels, Software Selectable
- Programmable LCD Timing module:
  - Multiple LCD timing sources available
  - Up to four commons: static, 1/2, 1/3 or 1/4 multiplex
  - Static, 1/2 or 1/3 bias configuration
- On-Chip LCD Boost Voltage Regulator for Contrast Control
- Charge Time Measurement Unit (CTMU) for Capacitive Touch Sensing
- ADC for Resistive Touch Sensing

Low-Power Features:

- Power-Managed modes:
  - Run: CPU On, Peripherals On
  - Idle: CPU Off, Peripherals On
  - Sleep: CPU Off, Peripherals Off
- Two-Speed Oscillator Start-up

Flexible Oscillator Structure:

- Two Crystal modes, 4-25 MHz
- Two External Clock modes, up to 48 MHz
- 4x Phase Lock Loop (PLL)
- Internal Oscillator Block with PLL:
  - Eight user-selectable frequencies from 31.25 kHz to 8 MHz
- Secondary Oscillator using Timer1 at 32 kHz
- Fail-Safe Clock Monitor (FSCM):
  - Allows for safe shutdown if peripheral clock fails

Peripheral Highlights:

- High-Current Sink/Source 25 mA/25 mA (PORTB and PORTC)
- Up to Four External Interrupts
- Four 8-Bit/16-Bit Timer/Counter modules
- Two Capture/Compare/PWM (CCP) modules
- Master Synchronous Serial Port (MSSP) module with Two Modes of Operation:
  - 3-Wire/4-Wire SPI (supports all four SPI modes)
  - I^2C™ Master and Slave mode
- One Addressable USART module
- One Enhanced Addressable USART module:
  - LIN/J2602 support
  - Auto-wake-up on Start bit and Break character
  - Auto-Baud Detect (ABD)
- 12-Bit, up to 12-Channel A/D Converter:
  - Auto-acquisition
  - Conversion available during Sleep
- Two Analog Comparators
- Programmable Reference Voltage for Comparators
- Hardware Real-Time Clock and Calendar (RTCC) with Clock, Calendar and Alarm Functions
- Charge Time Measurement Unit (CTMU):
  - Capacitance measurement
  - Time measurement with 1 ns typical resolution

Note: This document is supplemented by the *"PIC18F87J90 Family Data Sheet"* (DS39933). See **Section 1.0 "Device Overview"**.

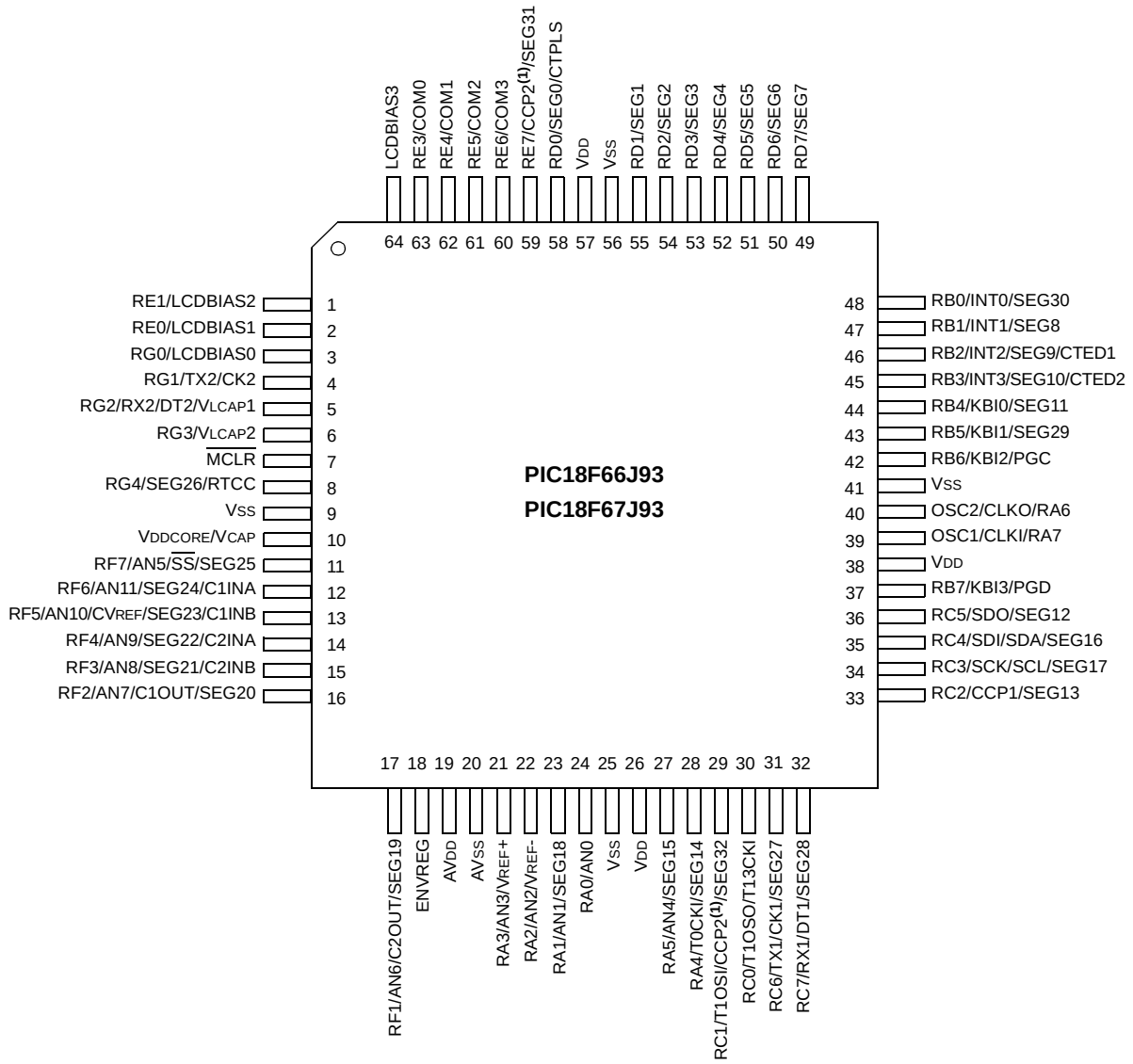
Device	Flash Program Memory (Bytes)	SRAM Data Memory (Bytes)	I/O	LCD (Pixels)	Timers 8/16-Bit	CCP	MSSP		EUSART AUSART	12-Bit A/D (Channels)	Comparators	BOR/LVD	RTCC	CTMU
							SPI	Master I^2C™						
PIC18F66J93	64K	3,923	51	132	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes
PIC18F67J93	128K	3,923	51	132	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes
PIC18F86J93	64K	3,923	67	192	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes
PIC18F87J93	128K	3,923	67	192	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes

Special Microcontroller Features:

- 10,000 Erase/Write Cycle Flash Program Memory, Typical
- Flash Retention 20 Years, Minimum
- Self-Programmable under Software Control
- Flash Program Memory has Word Write Capability for Data EEPROM Emulators
- Priority Levels for Interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
  - Programmable period from 4 ms to 131s
- In-Circuit Serial Programming™ (ICSP™) via Two Pins
- In-Circuit Debug via Two Pins
- Operating Voltage Range: 2.0V to 3.6V
- 5.5V Tolerant Input (digital pins only)
- Selectable Open-Drain Configuration for Serial Communication and CCP Pins for Driving Outputs up to 5V
- On-Chip 2.5V Regulator

Pin Diagrams – PIC18F6XJ93

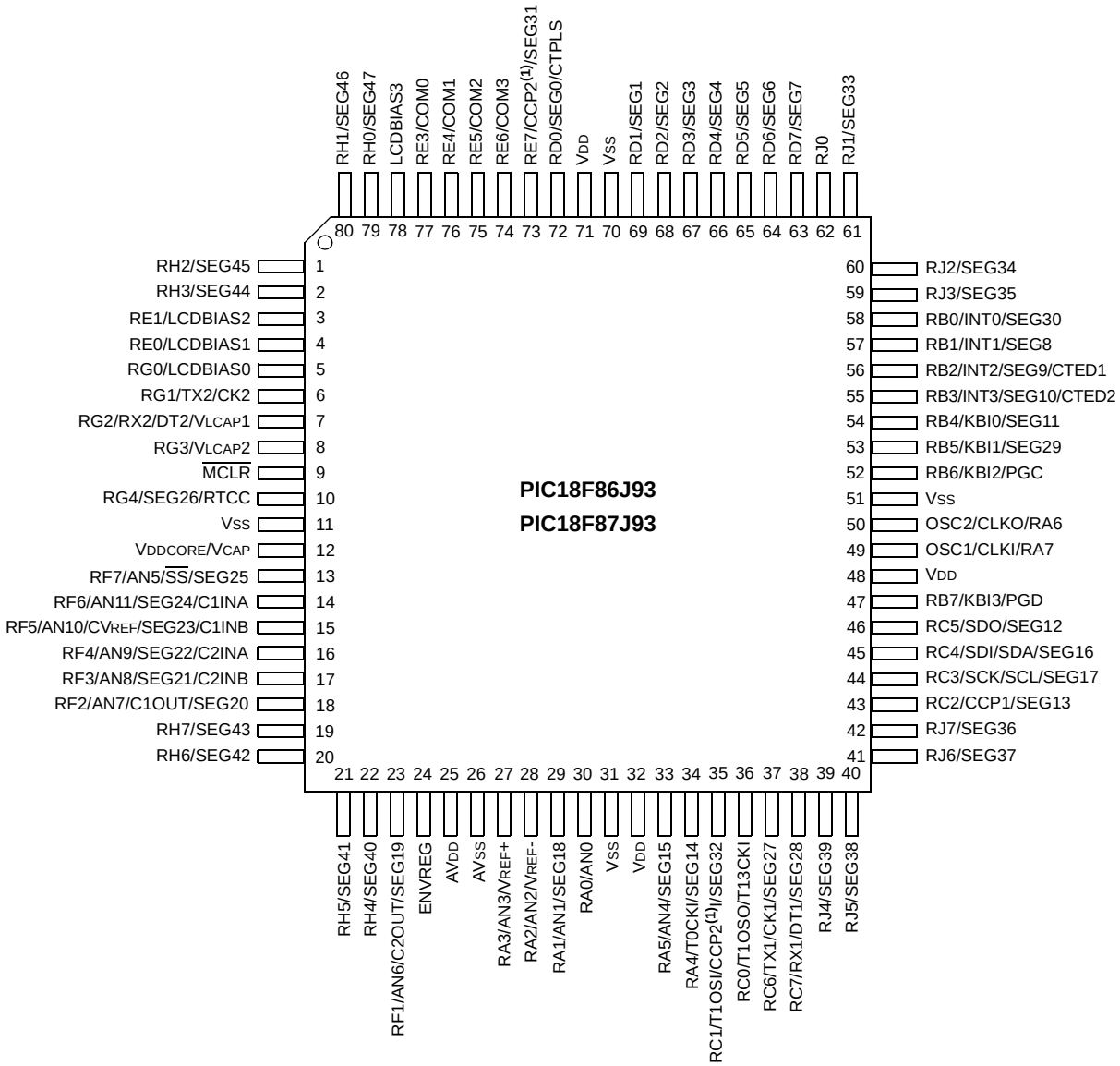
64-Pin TQFP



Note 1: The CCP2 pin placement depends on the CCP2MX Configuration bit setting.

Pin Diagrams – PIC18F8XJ93

80-Pin TQFP



Note 1: The CCP2 pin placement depends on the CCP2MX Configuration bit setting.

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1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- PIC18F66J93
- PIC18F67J93
- PIC18F86J93
- PIC18F87J93

Note: This data sheet documents only the devices' features and specifications that are in addition to the features and specifications of the PIC18F87J90 family devices. For information on the features and specifications shared by the PIC18F87J93 family and PIC18F87J90 family devices, see the *"PIC18F87J90 Family Data Sheet"* (DS39933).

The PIC18F87J93 family of devices offers the advantages of all PIC18 microcontrollers – high computational performance, a rich feature set and economical price – with the addition of a versatile, on-chip LCD driver. These features make the PIC18F87J93 family a logical choice for many high-performance applications where price is a primary consideration.

1.1 Special Features

- **12-Bit A/D Converter:** The PIC18F87J93 family implements a 12-bit A/D converter. A/D converters in both families incorporate programmable acquisition time. This allows for a channel to be selected and a conversion to be initiated, without waiting for a sampling period and thus, reducing code overhead.
- **Data RAM:** The PIC18F87J93 family devices have 3,923 bytes of RAM.

1.2 Details on Individual Family Members

Devices in the PIC18F87J93 family are available in 64-pin and 80-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in the following ways:

- Flash Program Memory (64 Kbytes for PIC18FX6J93 devices and 128 Kbytes for PIC18FX7J93).
- LCD Pixels:
  - 64-pin devices – 132 pixels (33 SEGs x 4 COMs)
  - 80-pin devices – 192 pixels (48 SEGs x 4 COMs)
- I/O Ports (seven bidirectional ports on PIC18F6XJ93 devices and nine bidirectional ports on PIC18F8XJ93 devices).

All other features for devices in this family are identical and are summarized in Table 1-1 and Table 1-2.

The devices' block diagrams are given in Figure 1-1 and Figure 1-2.

The pinouts for all devices are listed in Table 1-3 and Table 1-4.

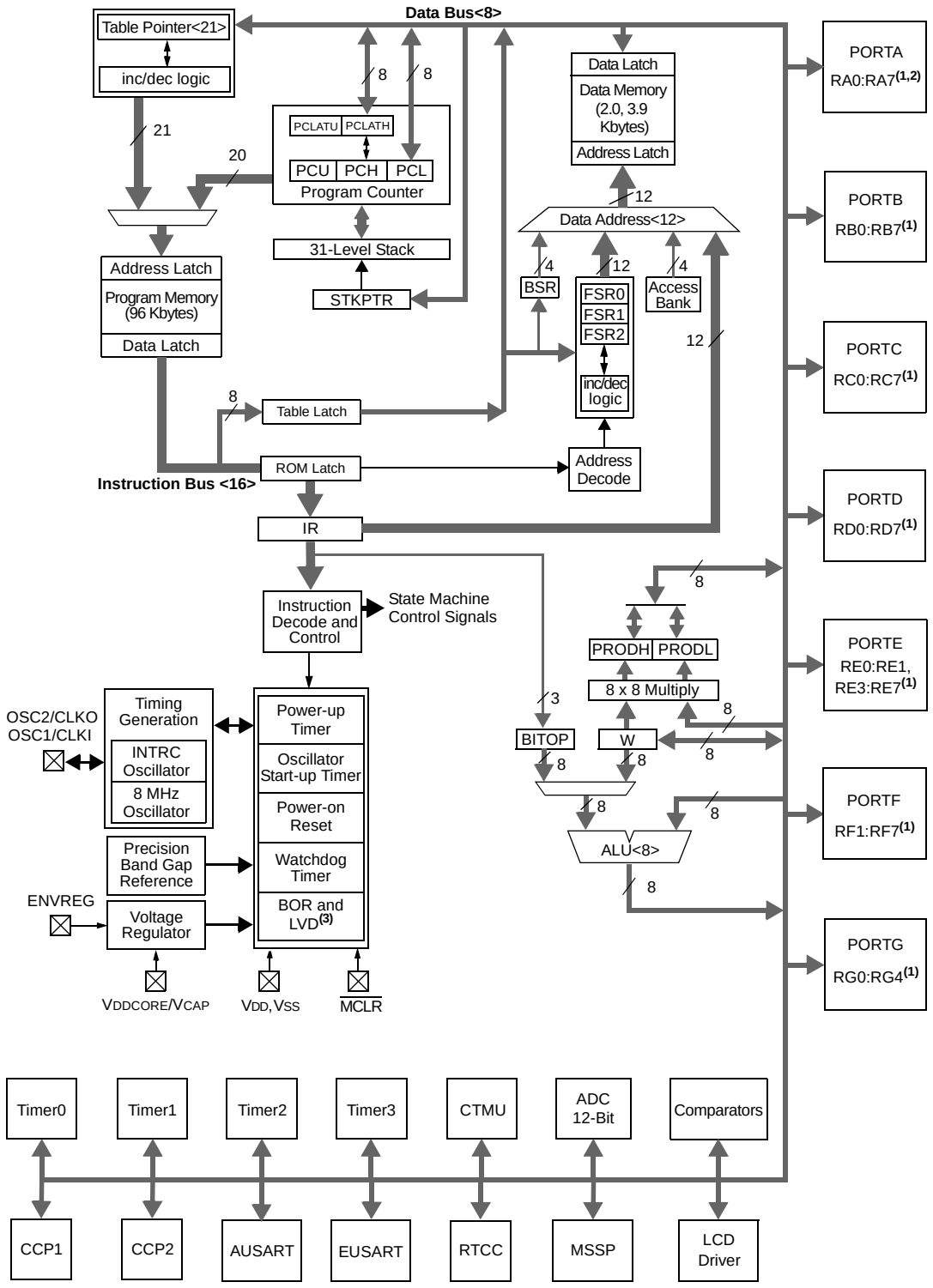
TABLE 1-1: DEVICE FEATURES FOR THE PIC18F6XJ93 (64-PIN DEVICES)

Features	PIC18F66J93	PIC18F67J93
Operating Frequency	DC – 48 MHz	
Program Memory (Bytes)	64K	128K
Program Memory (Instructions)	32,768	65,536
Data Memory (Bytes)	3,923	3,923
Interrupt Sources	29	
I/O Ports	Ports A, B, C, D, E, F, G	
LCD Driver (available pixels to drive)	132 (33 SEGs x 4 COMs)	
Timers	4	
Comparators	2	
CTMU	Yes	
RTCC	Yes	
Capture/Compare/PWM Modules	2	
Serial Communications	MSSP, Addressable USART, Enhanced USART	
12-Bit Analog-to-Digital Module	12 Input Channels	
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, $\overline{\text{MCLR}}$, WDT (PWRT, OST)	
Instruction Set	75 Instructions, 83 with Extended Instruction Set Enabled	
Packages	64-Pin TQFP	

TABLE 1-2: DEVICE FEATURES FOR THE PIC18F8XJ93 (80-PIN DEVICES)

Features	PIC18F86J93	PIC18F87J93
Operating Frequency	DC – 48 MHz	
Program Memory (Bytes)	64K	128K
Program Memory (Instructions)	32,768	65,536
Data Memory (Bytes)	3,923	3,923
Interrupt Sources	29	
I/O Ports	Ports A, B, C, D, E, F, G, H, J	
LCD Driver (available pixels to drive)	192 (48 SEGs x 4 COMs)	
Timers	4	
Comparators	2	
CTMU	Yes	
RTCC	Yes	
Capture/Compare/PWM Modules	2	
Serial Communications	MSSP, Addressable USART, Enhanced USART	
12-Bit Analog-to-Digital Module	12 Input Channels	
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, $\overline{\text{MCLR}}$, WDT (PWRT, OST)	
Instruction Set	75 Instructions, 83 with Extended Instruction Set Enabled	
Packages	80-Pin TQFP	

FIGURE 1-1: PIC18F6XJ93 (64-PIN) BLOCK DIAGRAM

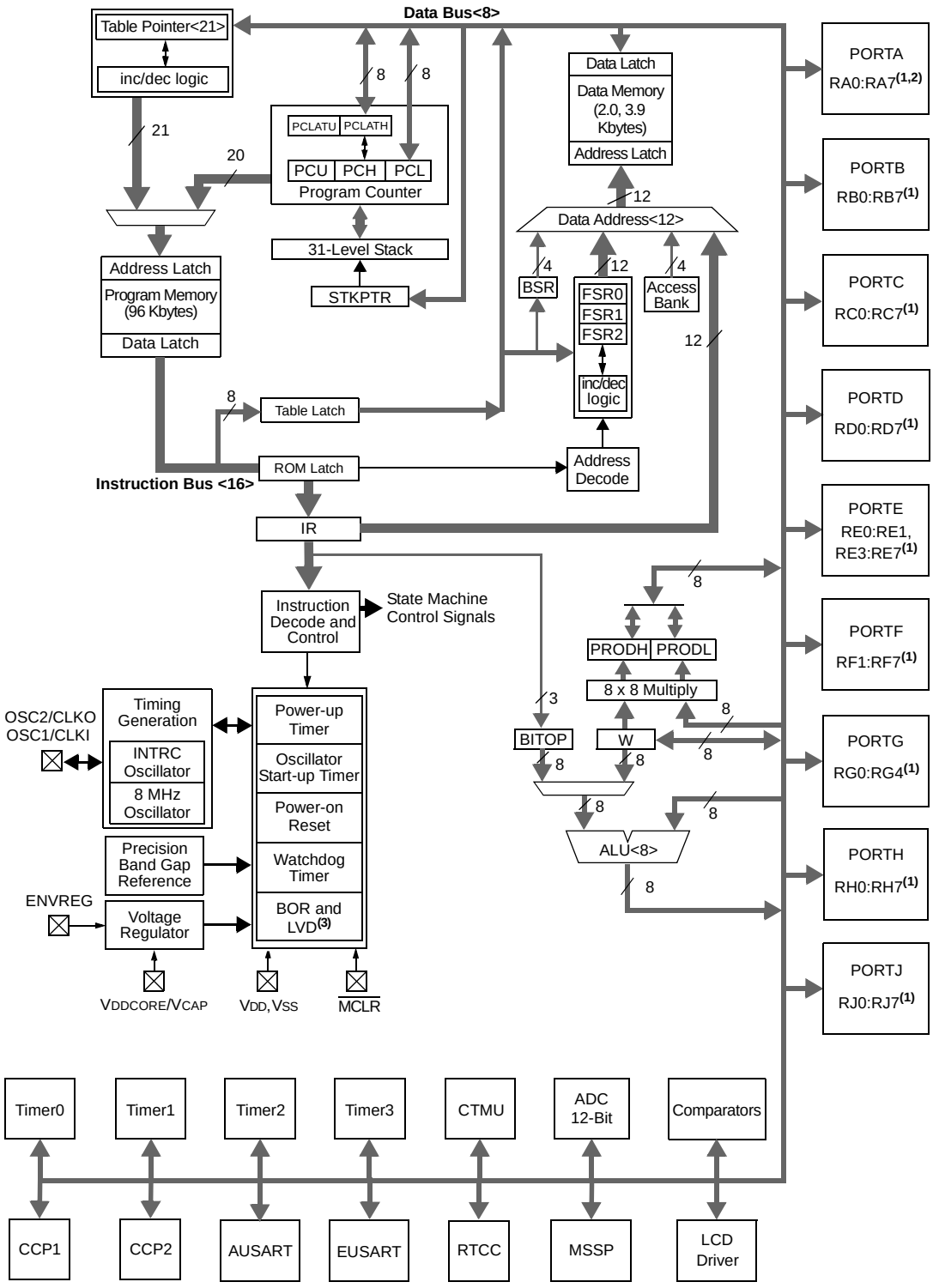


Note 1: See Table 1-3 for I/O port pin descriptions.

2: RA6 and RA7 are only available as digital I/Os in select oscillator modes.

3: Brown-out Reset and Low-Voltage Detect functions are provided when the on-board voltage regulator is enabled.

FIGURE 1-2: PIC18F8XJ93 (80-PIN) BLOCK DIAGRAM



Note 1: See Table 1-3 for I/O port pin descriptions.

2: RA6 and RA7 are only available as digital I/Os in select oscillator modes.

3: Brown-out Reset and Low-Voltage Detect functions are provided when the on-board voltage regulator is enabled.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
$\overline{MCLR}$	7	I	ST	Master Clear (input) or programming voltage (input). This pin is an active-low Reset to the device.
OSC1/CLKI/RA7	39			Oscillator crystal or external clock input.
OSC1		I	CMOS	Oscillator crystal input.
CLKI		I	CMOS	External clock source input. Always associated with pin function OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6	40			Oscillator crystal or clock output.
OSC2		O	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		O	—	In EC modes, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
				PORTA is a bidirectional I/O port.
RA0/AN0	24			
RA0		I/O	TTL	Digital I/O.
AN0		I	Analog	Analog Input 0.
RA1/AN1/SEG18	23			
RA1		I/O	TTL	Digital I/O.
AN1		I	Analog	Analog Input 1.
SEG18		O	Analog	SEG18 output for LCD.
RA2/AN2/V_{REF-}	22			
RA2		I/O	TTL	Digital I/O.
AN2		I	Analog	Analog Input 2.
V_{REF-}		I	Analog	A/D reference voltage (low) input.
RA3/AN3/V_{REF+}	21			
RA3		I/O	TTL	Digital I/O.
AN3		I	Analog	Analog Input 3.
V_{REF+}		I	Analog	A/D reference voltage (high) input.
RA4/T0CKI/SEG14	28			
RA4		I/O	ST	Digital I/O.
T0CKI		I	ST	Timer0 external clock input.
SEG14		O	Analog	SEG14 output for LCD.
RA5/AN4/SEG15	27			
RA5		I/O	TTL	Digital I/O.
AN4		I	Analog	Analog Input 4.
SEG15		O	Analog	SEG15 output for LCD.
RA6				See the OSC2/CLKO/RA6 pin.
RA7				See the OSC1/CLKI/RA7 pin.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number TQFP	Pin Type	Buffer Type	Description
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0/SEG30	48			
RB0		I/O	TTL	Digital I/O.
INT0		I	ST	External Interrupt 0.
SEG30		O	Analog	SEG30 output for LCD.
RB1/INT1/SEG8	47			
RB1		I/O	TTL	Digital I/O.
INT1		I	ST	External Interrupt 1.
SEG8		O	Analog	SEG8 output for LCD.
RB2/INT2/SEG9/CTED1	46			
RB2		I/O	TTL	Digital I/O.
INT2		I	ST	External Interrupt 2.
SEG9		O	Analog	SEG9 output for LCD.
CTED1		I	ST	CTMU Edge 1 input.
RB3/INT3/SEG10/CTED2	45			
RB3		I/O	TTL	Digital I/O.
INT3		I	ST	External Interrupt 3.
SEG10		O	Analog	SEG10 output for LCD.
CTED2		I	ST	CTMU Edge 2 input.
RB4/KBI0/SEG11	44			
RB4		I/O	TTL	Digital I/O.
KBI0		I	TTL	Interrupt-on-change pin.
SEG11		O	Analog	SEG11 output for LCD.
RB5/KBI1/SEG29	43			
RB5		I/O	TTL	Digital I/O.
KBI1		I	TTL	Interrupt-on-change pin.
SEG29		O	Analog	SEG29 output for LCD.
RB6/KBI2/PGC	42			
RB6		I/O	TTL	Digital I/O.
KBI2		I	TTL	Interrupt-on-change pin.
PGC		I/O	ST	In-Circuit Debugger and ICSP™ programming clock pin.
RB7/KBI3/PGD	37			
RB7		I/O	TTL	Digital I/O.
KBI3		I	TTL	Interrupt-on-change pin.
PGD		I/O	ST	In-Circuit Debugger and ICSP programming data pin.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTC is a bidirectional I/O port.
RC0/T1OSO/T13CKI	30			
RC0		I/O	ST	Digital I/O.
T1OSO		O	—	Timer1 oscillator output.
T13CKI		I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2/SEG32	29			
RC1		I/O	ST	Digital I/O.
T1OSI		I	CMOS	Timer1 oscillator input.
CCP2(1)		I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
SEG32		O	Analog	SEG32 output for LCD.
RC2/CCP1/SEG13	33			
RC2		I/O	ST	Digital I/O.
CCP1		I/O	ST	Capture 1 input/Compare 1 output/PWM1 output.
SEG13		O	Analog	SEG13 output for LCD.
RC3/SCK/SCL/SEG17	34			
RC3		I/O	ST	Digital I/O.
SCK		I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL		I/O	ST	Synchronous serial clock input/output for I^2C™ mode.
SEG17		O	Analog	SEG17 output for LCD.
RC4/SDI/SDA/SEG16	35			
RC4		I/O	ST	Digital I/O.
SDI		I	ST	SPI data in.
SDA		I/O	ST	I^2C data I/O.
SEG16		O	Analog	SEG16 output for LCD.
RC5/SDO/SEG12	36			
RC5		I/O	ST	Digital I/O.
SDO		O	—	SPI data out.
SEG12		O	Analog	SEG12 output for LCD.
RC6/TX1/CK1/SEG27	31			
RC6		I/O	ST	Digital I/O.
TX1		O	—	EUSART asynchronous transmit.
CK1		I/O	ST	EUSART synchronous clock (see related RX1/DT1).
SEG27		O	Analog	SEG27 output for LCD.
RC7/RX1/DT1/SEG28	32			
RC7		I/O	ST	Digital I/O.
RX1		I	ST	EUSART asynchronous receive.
DT1		I/O	ST	EUSART synchronous data (see related TX1/CK1).
SEG28		O	Analog	SEG28 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTD is a bidirectional I/O port.
RD0/SEG0/CTPLS	58			
RD0		I/O	ST	Digital I/O.
SEG0		O	Analog	SEG0 output for LCD.
CTPLS		O	—	CTMU pulse generator output.
RD1/SEG1	55			
RD1		I/O	ST	Digital I/O.
SEG1		O	Analog	SEG1 output for LCD.
RD2/SEG2	54			
RD2		I/O	ST	Digital I/O.
SEG2		O	Analog	SEG2 output for LCD.
RD3/SEG3	53			
RD3		I/O	ST	Digital I/O.
SEG3		O	Analog	SEG3 output for LCD.
RD4/SEG4	52			
RD4		I/O	ST	Digital I/O.
SEG4		O	Analog	SEG4 output for LCD.
RD5/SEG5	51			
RD5		I/O	ST	Digital I/O.
SEG5		O	Analog	SEG5 output for LCD.
RD6/SEG6	50			
RD6		I/O	ST	Digital I/O.
SEG6		O	Analog	SEG6 output for LCD.
RD7/SEG7	49			
RD7		I/O	ST	Digital I/O.
SEG7		O	Analog	SEG7 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTE is a bidirectional I/O port.
RE0/LCDBIAS1	2			
RE0		I/O	ST	Digital I/O.
LCDBIAS1		I	Analog	BIAS1 input for LCD.
RE1/LCDBIAS2	1			
RE1		I/O	ST	Digital I/O.
LCDBIAS2		I	Analog	BIAS2 input for LCD.
LCDBIAS3	64	I	Analog	BIAS3 input for LCD.
RE3/COM0	63			
RE3		I/O	ST	Digital I/O.
COM0		O	Analog	COM0 output for LCD.
RE4/COM1	62			
RE4		I/O	ST	Digital I/O.
COM1		O	Analog	COM1 output for LCD.
RE5/COM2	61			
RE5		I/O	ST	Digital I/O.
COM2		O	Analog	COM2 output for LCD.
RE6/COM3	60			
RE6		I/O	ST	Digital I/O.
COM3		O	Analog	COM3 output for LCD.
RE7/CCP2/SEG31	59			
RE7		I/O	ST	Digital I/O.
CCP2(2)		I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
SEG31		O	Analog	SEG31 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTF is a bidirectional I/O port.
RF1/AN6/C2OUT/SEG19	17			
RF1		I/O	ST	Digital I/O.
AN6		I	Analog	Analog Input 6.
C2OUT		O	—	Comparator 2 output.
SEG19		O	Analog	SEG19 output for LCD.
RF2/AN7/C1OUT/SEG20	16			
RF2		I/O	ST	Digital I/O.
AN7		I	Analog	Analog Input 7.
C1OUT		O	—	Comparator 1 output.
SEG20		O	Analog	SEG20 output for LCD.
RF3/AN8/SEG21/C2INB	15			
RF3		I/O	ST	Digital I/O.
AN8		I	Analog	Analog Input 8.
SEG21		O	Analog	SEG21 output for LCD.
C2INB		I	Analog	Comparator 2 input B.
RF4/AN9/SEG22/C2INA	14			
RF4		I/O	ST	Digital I/O.
AN9		I	Analog	Analog Input 9.
SEG22		O	Analog	SEG22 output for LCD
C2INA		I	Analog	Comparator 2 input A.
RF5/AN10/CVREF/ SEG23/C1INB	13			
RF5		I/O	ST	Digital I/O.
AN10		I	Analog	Analog Input 10.
CVREF		O	Analog	Comparator reference voltage output.
SEG23		O	Analog	SEG23 output for LCD.
C1INB		I	Analog	Comparator 1 input B.
RF6/AN11/SEG24/C1INA	12			
RF6		I/O	ST	Digital I/O.
AN11		I	Analog	Analog Input 11.
SEG24		O	Analog	SEG24 output for LCD
C1INA		I	Analog	Comparator 1 input A.
RF7/AN5/$\overline{SS}$/SEG25	11			
RF7		I/O	ST	Digital I/O.
AN5		O	Analog	Analog Input 5.
$\overline{SS}$		I	TTL	SPI slave select input.
SEG25		O	Analog	SEG25 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-3: PIC18F6XJ93 (64-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTG is a bidirectional I/O port.
RG0/LCDBIAS0	3			
RG0		I/O	ST	Digital I/O.
LCDBIAS0		I	Analog	BIAS0 input for LCD.
RG1/TX2/CK2	4			
RG1		I/O	ST	Digital I/O.
TX2		O	—	AUSART asynchronous transmit.
CK2		I/O	ST	AUSART synchronous clock (see related RX2/DT2).
RG2/RX2/DT2/VLCAP1	5			
RG2		I/O	ST	Digital I/O.
RX2		I	ST	AUSART asynchronous receive.
DT2		I/O	ST	AUSART synchronous data (see related TX2/CK2).
VLCAP1		I	Analog	LCD charge pump capacitor input.
RG3/VLCAP2	6			
RG3		I/O	ST	Digital I/O.
VLCAP2		I	Analog	LCD charge pump capacitor input.
RG4/SEG26/RTCC	8			
RG4		I/O	ST	Digital I/O.
SEG26		O	Analog	SEG26 output for LCD.
RTCC		O	—	RTCC output
VSS	9, 25, 41, 56	P	—	Ground reference for logic and I/O pins.
VDD	26, 38, 57	P	—	Positive supply for logic and I/O pins.
AVSS	20	P	—	Ground reference for analog modules.
AVDD	19	P	—	Positive supply for analog modules.
ENVREG	18	I	ST	Enable for on-chip voltage regulator.
VDDCORE/VCAP	10			Core logic power or external filter capacitor connection.
VDDCORE		P	—	Positive supply for microcontroller core logic (regulator disabled).
VCAP		P	—	External filter capacitor connection (regulator enabled).

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
$\overline{MCLR}$	9	I	ST	Master Clear (input) or programming voltage (input). This pin is an active-low Reset to the device.
OSC1/CLKI/RA7	49			Oscillator crystal or external clock input.
OSC1		I	CMOS	Oscillator crystal input.
CLKI		I	CMOS	External clock source input. Always associated with pin function OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6	50			Oscillator crystal or clock output.
OSC2		O	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		O	—	In EC modes, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
				PORTA is a bidirectional I/O port.
RA0/AN0	30			
RA0		I/O	TTL	Digital I/O.
AN0		I	Analog	Analog Input 0.
RA1/AN1/SEG18	29			
RA1		I/O	TTL	Digital I/O.
AN1		I	Analog	Analog Input 1.
SEG18		O	Analog	SEG18 output for LCD.
RA2/AN2/VREF-	28			
RA2		I/O	TTL	Digital I/O.
AN2		I	Analog	Analog Input 2.
VREF-		I	Analog	A/D reference voltage (low) input.
RA3/AN3/VREF+	27			
RA3		I/O	TTL	Digital I/O.
AN3		I	Analog	Analog Input 3.
VREF+		I	Analog	A/D reference voltage (high) input.
RA4/T0CKI/SEG14	34			
RA4		I/O	ST	Digital I/O.
T0CKI		I	ST	Timer0 external clock input.
SEG14		O	Analog	SEG14 output for LCD.
RA5/AN4/SEG15	33			
RA5		I/O	TTL	Digital I/O.
AN4		I	Analog	Analog Input 4.
SEG15		O	Analog	SEG15 output for LCD.
RA6				See the OSC2/CLKO/RA6 pin.
RA7				See the OSC1/CLKI/RA7 pin.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0/SEG30	58			
RB0		I/O	TTL	Digital I/O.
INT0		I	ST	External Interrupt 0.
SEG30		O	Analog	SEG30 output for LCD.
RB1/INT1/SEG8	57			
RB1		I/O	TTL	Digital I/O.
INT1		I	ST	External Interrupt 1.
SEG8		O	Analog	SEG8 output for LCD.
RB2/INT2/SEG9/CTED1	56			
RB2		I/O	TTL	Digital I/O.
INT2		I	ST	External Interrupt 2.
SEG9		O	Analog	SEG9 output for LCD.
CTED1		I	ST	CTMU Edge 1 input.
RB3/INT3/SEG10/ CTED2	55			
RB3		I/O	TTL	Digital I/O.
INT3		I	ST	External Interrupt 3.
SEG10		O	Analog	SEG10 output for LCD.
CTED2		I	ST	CTMU Edge 2 input.
RB4/KBI0/SEG11	54			
RB4		I/O	TTL	Digital I/O.
KBI0		I	TTL	Interrupt-on-change pin.
SEG11		O	Analog	SEG11 output for LCD.
RB5/KBI1/SEG29	53			
RB5		I/O	TTL	Digital I/O.
KBI1		I	TTL	Interrupt-on-change pin.
SEG29		O	Analog	SEG29 output for LCD.
RB6/KBI2/PGC	52			
RB6		I/O	TTL	Digital I/O.
KBI2		I	TTL	Interrupt-on-change pin.
PGC		I/O	ST	In-Circuit Debugger and ICSP™ programming clock pin.
RB7/KBI3/PGD	47			
RB7		I/O	TTL	Digital I/O.
KBI3		I	TTL	Interrupt-on-change pin.
PGD		I/O	ST	In-Circuit Debugger and ICSP programming data pin.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTC is a bidirectional I/O port.
RC0/T1OSO/T13CKI	36			
RC0		I/O	ST	Digital I/O.
T1OSO		O	—	Timer1 oscillator output.
T13CKI		I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2/SEG32	35			
RC1		I/O	ST	Digital I/O.
T1OSI		I	CMOS	Timer1 oscillator input.
CCP2(1)		I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
SEG32		O	Analog	SEG32 output for LCD.
RC2/CCP1/SEG13	43			
RC2		I/O	ST	Digital I/O.
CCP1		I/O	ST	Capture 1 input/Compare 1 output/PWM1 output.
SEG13		O	Analog	SEG13 output for LCD.
RC3/SCK/SCL/SEG17	44			
RC3		I/O	ST	Digital I/O.
SCK		I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL		I/O	ST	Synchronous serial clock input/output for I^2C™ mode.
SEG17		O	Analog	SEG17 output for LCD.
RC4/SDI/SDA/SEG16	45			
RC4		I/O	ST	Digital I/O.
SDI		I	ST	SPI data in.
SDA		I/O	ST	I^2C data I/O.
SEG16		O	Analog	SEG16 output for LCD.
RC5/SDO/SEG12	46			
RC5		I/O	ST	Digital I/O.
SDO		O	—	SPI data out.
SEG12		O	Analog	SEG12 output for LCD.
RC6/TX1/CK1/SEG27	37			
RC6		I/O	ST	Digital I/O.
TX1		O	—	EUSART asynchronous transmit.
CK1		I/O	ST	EUSART synchronous clock (see related RX1/DT1).
SEG27		O	Analog	SEG27 output for LCD.
RC7/RX1/DT1/SEG28	38			
RC7		I/O	ST	Digital I/O.
RX1		I	ST	EUSART asynchronous receive.
DT1		I/O	ST	EUSART synchronous data (see related TX1/CK1).
SEG28		O	Analog	SEG28 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTD is a bidirectional I/O port.
RD0/SEG0/CTPLS	72			
RD0		I/O	ST	Digital I/O.
SEG0		O	Analog	SEG0 output for LCD.
CTPLS		O	ST	CTMU pulse generator output.
RD1/SEG1	69			
RD1		I/O	ST	Digital I/O.
SEG1		O	Analog	SEG1 output for LCD.
RD2/SEG2	68			
RD2		I/O	ST	Digital I/O.
SEG2		O	Analog	SEG2 output for LCD.
RD3/SEG3	67			
RD3		I/O	ST	Digital I/O.
SEG3		O	Analog	SEG3 output for LCD.
RD4/SEG4	66			
RD4		I/O	ST	Digital I/O.
SEG4		O	Analog	SEG4 output for LCD.
RD5/SEG5	65			
RD5		I/O	ST	Digital I/O.
SEG5		O	Analog	SEG5 output for LCD.
RD6/SEG6	64			
RD6		I/O	ST	Digital I/O.
SEG6		O	Analog	SEG6 output for LCD.
RD7/SEG7	63			
RD7		I/O	ST	Digital I/O.
SEG7		O	Analog	SEG7 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTE is a bidirectional I/O port.
RE0/LCDBIAS1	4			
RE0		I/O	ST	Digital I/O.
LCDBIAS1		I	Analog	BIAS1 input for LCD.
RE1/LCDBIAS2	3			
RE1		I/O	ST	Digital I/O.
LCDBIAS2		I	Analog	BIAS2 input for LCD.
LCDBIAS3	78	I	Analog	BIAS3 input for LCD.
RE3/COM0	77			
RE3		I/O	ST	Digital I/O.
COM0		O	Analog	COM0 output for LCD.
RE4/COM1	76			
RE4		I/O	ST	Digital I/O.
COM1		O	Analog	COM1 output for LCD.
RE5/COM2	75			
RE5		I/O	ST	Digital I/O.
COM2		O	Analog	COM2 output for LCD.
RE6/COM3	74			
RE6		I/O	ST	Digital I/O.
COM3		O	Analog	COM3 output for LCD.
RE7/CCP2/SEG31	73			
RE7		I/O	ST	Digital I/O.
CCP2(2)		I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
SEG31		O	Analog	SEG31 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTF is a bidirectional I/O port.
RF1/AN6/C2OUT/SEG19	23			
RF1		I/O	ST	Digital I/O.
AN6		I	Analog	Analog Input 6.
C2OUT		O	—	Comparator 2 output.
SEG19		O	Analog	SEG19 output for LCD.
RF2/AN7/C1OUT/SEG20	18			
RF2		I/O	ST	Digital I/O.
AN7		I	Analog	Analog Input 7.
C1OUT		O	—	Comparator 1 output.
SEG20		O	Analog	SEG20 output for LCD.
RF3/AN8/SEG21/C2INB	17			
RF3		I/O	ST	Digital I/O.
AN8		I	Analog	Analog Input 8.
SEG21		O	Analog	SEG21 output for LCD.
C2INB		I	Analog	Comparator 2 input B.
RF4/AN9/SEG22/C2INA	16			
RF4		I/O	ST	Digital I/O.
AN9		I	Analog	Analog Input 9.
SEG22		O	Analog	SEG22 output for LCD.
C2INA		I	Analog	Comparator 2 input A.
RF5/AN10/CVREF/ SEG23/C1INB	15			
RF5		I/O	ST	Digital I/O.
AN10		I	Analog	Analog Input 10.
CVREF		O	Analog	Comparator reference voltage output.
SEG23		O	Analog	SEG23 output for LCD.
C1INB		I	Analog	Comparator 1 input B.
RF6/AN11/SEG24/C1INA	14			
RF6		I/O	ST	Digital I/O.
AN11		I	Analog	Analog Input 11.
SEG24		O	Analog	SEG24 output for LCD.
C1INA		I	Analog	Comparator 1 input A.
RF7/AN5/$\overline{SS}$/SEG25	13			
RF7		I/O	ST	Digital I/O.
AN5		O	Analog	Analog Input 5.
$\overline{SS}$		I	TTL	SPI slave select input.
SEG25		O	Analog	SEG25 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTG is a bidirectional I/O port.
RG0/LCDBIAS0	5			
RG0		I/O	ST	Digital I/O.
LCDBIAS0		I	Analog	BIAS0 input for LCD.
RG1/TX2/CK2	6			
RG1		I/O	ST	Digital I/O.
TX2		O	—	AUSART asynchronous transmit.
CK2		I/O	ST	AUSART synchronous clock (see related RX2/DT2).
RG2/RX2/DT2/VLCAP1	7			
RG2		I/O	ST	Digital I/O.
RX2		I	ST	AUSART asynchronous receive.
DT2		I/O	ST	AUSART synchronous data (see related TX2/CK2).
VLCAP1		I	Analog	LCD charge pump capacitor input.
RG3/VLCAP2	8			
RG3		I/O	ST	Digital I/O.
VLCAP2		I	Analog	LCD charge pump capacitor input.
RG4/SEG26/RTCC	10			
RG4		I/O	ST	Digital I/O.
SEG26		O	Analog	SEG26 output for LCD.
RTCC		O	—	RTCC output.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTH is a bidirectional I/O port.
RH0/SEG47	79			
RH0		I/O	ST	Digital I/O.
SEG47		O	Analog	SEG47 output for LCD.
RH1/SEG46	80			
RH1		I/O	ST	Digital I/O.
SEG46		O	Analog	SEG46 output for LCD.
RH2/SEG45	1			
RH2		I/O	ST	Digital I/O.
SEG45		O	Analog	SEG45 output for LCD.
RH3/SEG44	2			
RH3		I/O	ST	Digital I/O.
SEG44		O	Analog	SEG44 output for LCD.
RH4/SEG40	22			
RH4		I/O	ST	Digital I/O.
SEG40		O	Analog	SEG40 output for LCD.
RH5/SEG41	21			
RH5		I/O	ST	Digital I/O.
SEG41		O	Analog	SEG41 output for LCD.
RH6/SEG42	20			
RH6		I/O	ST	Digital I/O.
SEG42		O	Analog	SEG42 output for LCD.
RH7/SEG43	19			
RH7		I/O	ST	Digital I/O.
SEG43		O	Analog	SEG43 output for LCD.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD})

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

TABLE 1-4: PIC18F8XJ93 (80-PIN DEVICE) PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTJ is a bidirectional I/O port.
RJ0	62	I/O	ST	Digital I/O.
RJ1/SEG33	61			
RJ1		I/O	ST	Digital I/O.
SEG33		O	Analog	SEG33 output for LCD.
RJ2/SEG34	60			
RJ2		I/O	ST	Digital I/O.
SEG34		O	Analog	SEG34 output for LCD.
RJ3/SEG35	59			
RJ3		I/O	ST	Digital I/O.
SEG35		O	Analog	SEG35 output for LCD.
RJ4/SEG39	39			
RJ4		I/O	ST	Digital I/O.
SEG39		O	Analog	SEG39 output for LCD.
RJ5/SEG38	40			
RJ5		I/O	ST	Digital I/O
SEG38		O	Analog	SEG38 output for LCD.
RJ6/SEG37	41			
RJ6		I/O	ST	Digital I/O.
SEG37		O	Analog	SEG37 output for LCD.
RJ7/SEG36	42			
RJ7		I/O	ST	Digital I/O.
SEG36		O	Analog	SEG36 output for LCD.
VSS	11, 31, 51, 70	P	—	Ground reference for logic and I/O pins.
VDD	32, 48, 71	P	—	Positive supply for logic and I/O pins.
AVSS	26	P	—	Ground reference for analog modules.
AVDD	25	P	—	Positive supply for analog modules.
ENVREG	24	I	ST	Enable for on-chip voltage regulator.
VDDCORE/VCAP	12			Core logic power or external filter capacitor connection.
VDDCORE		P	—	Positive supply for microcontroller core logic (regulator disabled).
VCAP		P	—	External filter capacitor connection (regulator enabled).

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

2.0 12-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) converter module has 12 inputs for all PIC18F87J93 family devices. This module allows conversion of an analog input signal to a corresponding 12-bit digital number.

The module has these registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

The ADCON0 register, shown in Register 2-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 2-2, configures the functions of the port pins. The ADCON2 register, shown in Register 2-3, configures the A/D clock source, programmed acquisition time and justification.

REGISTER 2-1: ADCON0: A/D CONTROL REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADCAL	—	CHS3	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	ADON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **ADCAL:** A/D Calibration bit
1 = Calibration is performed on next A/D conversion
0 = Normal A/D converter operation (no calibration is performed)

bit 6 **Unimplemented:** Read as ‘0’

bit 5-2 **CHS<3:0>:** Analog Channel Select bits
0000 = Channel 00 (AN0)
0001 = Channel 01 (AN1)
0010 = Channel 02 (AN2)
0011 = Channel 03 (AN3)
0100 = Channel 04 (AN4)
0101 = Channel 05 (AN5)
0110 = Channel 06 (AN6)
0111 = Channel 07 (AN7)
1000 = Channel 08 (AN8)
1001 = Channel 09 (AN9)
1010 = Channel 10 (AN10)
1011 = Channel 11 (AN11)
11xx = Unused

bit 1 **GO/$\overline{\text{DONE}}$:** A/D Conversion Status bit
When ADON = 1:
1 = A/D conversion in progress
0 = A/D Idle

bit 0 **ADON:** A/D On bit
1 = A/D converter module is enabled
0 = A/D converter module is disabled

REGISTER 2-2: ADCON1: A/D CONTROL REGISTER 1

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TRIGSEL	—	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **TRIGSEL:** Special Trigger Select bit
1 = Selects the special trigger from the CTMU
0 = Selects the special trigger from the CCP2

bit 6 **Unimplemented:** Read as '0'

bit 5 **VCFG1:** Voltage Reference Configuration bit (V_{REF-} source)
1 = V_{REF-} (AN2)
0 = AV_{SS}

bit 4 **VCFG0:** Voltage Reference Configuration bit (V_{REF+} source)
1 = V_{REF+} (AN3)
0 = AV_{DD}

bit 3-0 **PCFG<3:0>:** A/D Port Configuration Control bits:

PCFG<3:0>	AN11	AN10	AN9	AN8	AN7	AN6	AN5	AN4	AN3	AN2	AN1	AN0
0000	A	A	A	A	A	A	A	A	A	A	A	A
0001	A	A	A	A	A	A	A	A	A	A	A	A
0010	A	A	A	A	A	A	A	A	A	A	A	A
0011	A	A	A	A	A	A	A	A	A	A	A	A
0100	D	A	A	A	A	A	A	A	A	A	A	A
0101	D	D	A	A	A	A	A	A	A	A	A	A
0110	D	D	D	A	A	A	A	A	A	A	A	A
0111	D	D	D	D	A	A	A	A	A	A	A	A
1000	D	D	D	D	D	A	A	A	A	A	A	A
1001	D	D	D	D	D	D	A	A	A	A	A	A
1010	D	D	D	D	D	D	D	A	A	A	A	A
1011	D	D	D	D	D	D	D	D	A	A	A	A
1100	D	D	D	D	D	D	D	D	D	A	A	A
1101	D	D	D	D	D	D	D	D	D	D	A	A
1110	D	D	D	D	D	D	D	D	D	D	D	A
1111	D	D	D	D	D	D	D	D	D	D	D	D

A = Analog input D = Digital I/O

REGISTER 2-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	—	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ADFM:** A/D Result Format Select bit
1 = Right justified
0 = Left justified

bit 6 **Unimplemented:** Read as '0'

bit 5-3 **ACQT<2:0>:** A/D Acquisition Time Select bits
111 = 20 TAD
110 = 16 TAD
101 = 12 TAD
100 = 8 TAD
011 = 6 TAD
010 = 4 TAD
001 = 2 TAD
000 = 0 TAD(1)

bit 2-0 **ADCS<2:0>:** A/D Conversion Clock Select bits
111 = FRC (clock derived from A/D RC oscillator)(1)
110 = FOSC/64
101 = FOSC/16
100 = FOSC/4
011 = FRC (clock derived from A/D RC oscillator)(1)
010 = FOSC/32
001 = FOSC/8
000 = FOSC/2

Note 1: If the A/D FRC clock source is selected, a delay of one TCY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

The analog reference voltage is software selectable to either the device's positive and negative supply voltage (AV_{DD} and AV_{SS}) or the voltage level on the RA3/AN3/V_{REF+} and RA2/AN2/V_{REF-} pins.

The A/D converter has a unique feature of being able to operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

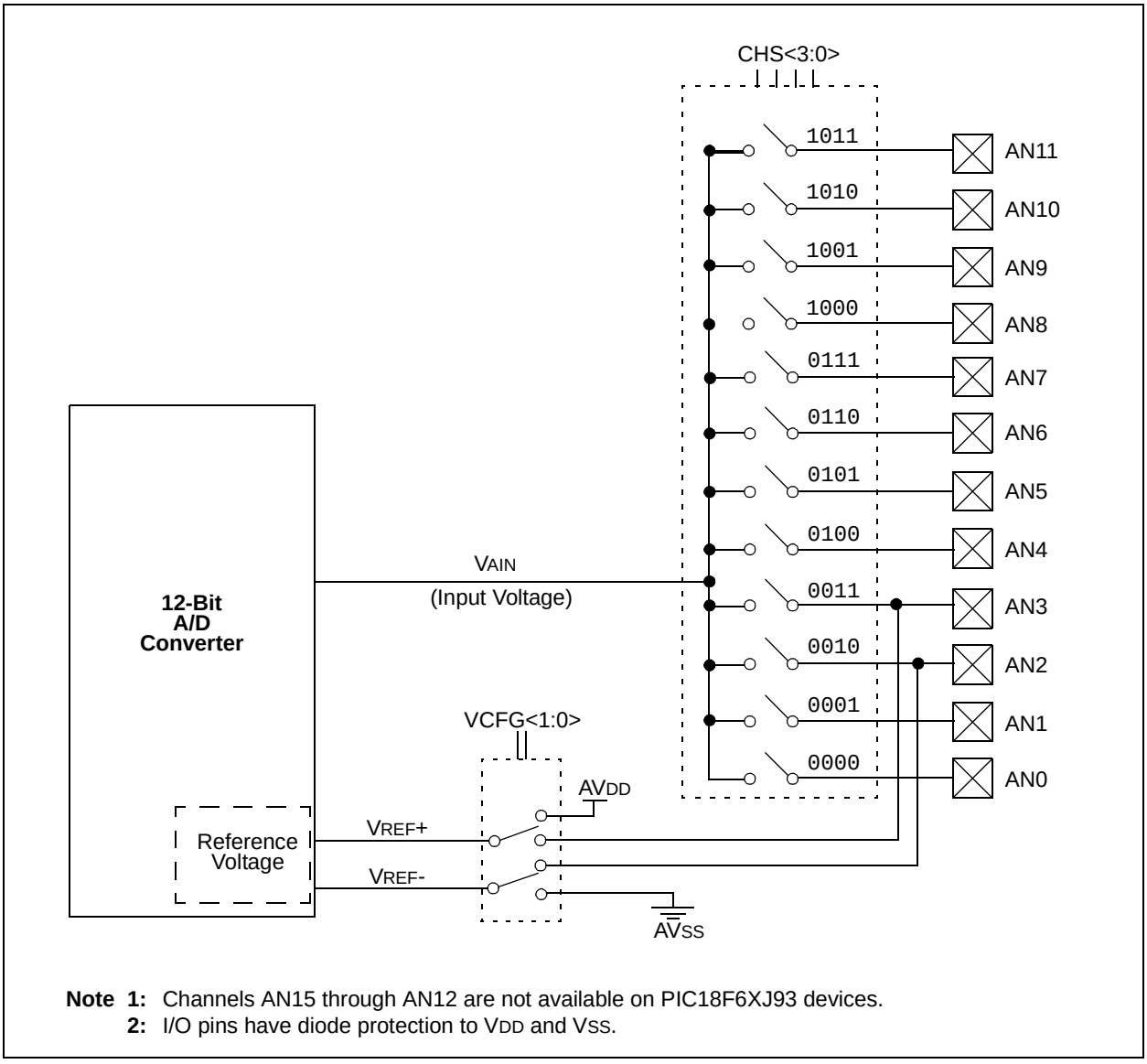
The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

Each port pin associated with the A/D converter can be configured as an analog input or as a digital I/O. The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/$\overline{\text{DONE}}$ bit (ADCON0<1>) is cleared and the A/D Interrupt Flag bit, ADIF, is set.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted. The value in the ADRESH:ADRESL register pair is not modified for a Power-on Reset. These registers will contain unknown data after a Power-on Reset.

The block diagram of the A/D module is shown in Figure 2-1.

FIGURE 2-1: A/D BLOCK DIAGRAM(1,2)



Note 1: Channels AN15 through AN12 are not available on PIC18F6XJ93 devices.
2: I/O pins have diode protection to V_{DD} and V_{SS}.

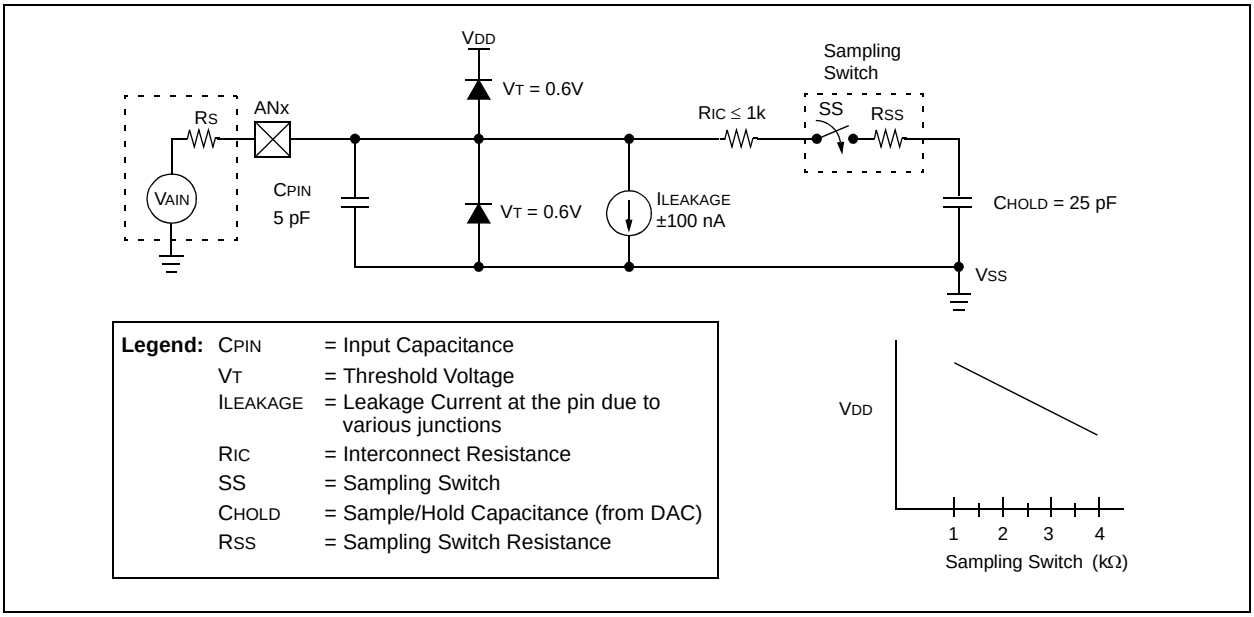
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 2.1 "A/D Acquisition Requirements"**. After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

The following steps should be followed to do an A/D conversion:

1. Configure the A/D module:
   - Configure analog pins, voltage reference and digital I/O (ADCON1)
   - Select A/D input channel (ADCON0)
   - Select A/D acquisition time (ADCON2)
   - Select A/D conversion clock (ADCON2)
   - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
   - Clear ADIF bit
   - Set ADIE bit
   - Set GIE bit
3. Wait the required acquisition time (if required).
4. Start conversion:
   - Set GO/DONE bit (ADCON0<1>)
5. Wait for A/D conversion to complete, by either:
   - Polling for the GO/DONE bit to be cleared

   OR
   - Waiting for the A/D interrupt
6. Read A/D Result registers (ADRESH:ADRESL); clear ADIF bit, if required.
7. For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before next acquisition starts.

FIGURE 2-2: ANALOG INPUT MODEL



2.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 2-2. The source impedance (RS) and the internal sampling switch (RSS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RSS) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). **The maximum recommended impedance for analog sources is 2.5 kΩ.** After the analog input channel is selected (changed), the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note:	When the conversion is started, the holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 2-1 may be used. This equation assumes that 1/2 LSb error is used (1,024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Equation 2-3 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

CHOLD	=	25 pF
Rs	=	2.5 kΩ
Conversion Error	≤	1/2 LSb
VDD	=	3V → Rss = 2 kΩ
Temperature	=	85°C (system max.)

EQUATION 2-1: ACQUISITION TIME

$$T_{ACQ} = \text{Amplifier Settling Time} + \text{Holding Capacitor Charging Time} + \text{Temperature Coefficient}$$
$$= T_{AMP} + T_C + T_{COFF}$$

EQUATION 2-2: A/D MINIMUM CHARGING TIME

$$V_{HOLD} = (V_{REF} - (V_{REF}/2048)) \cdot (1 - e^{(-T_C/C_{HOLD}(R_{IC} + R_{SS} + R_S))})$$
or
$$T_C = -(C_{HOLD})(R_{IC} + R_{SS} + R_S) \ln(1/2048)$$

EQUATION 2-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

$$T_{ACQ} = T_{AMP} + T_C + T_{COFF}$$
$$T_{AMP} = 0.2\ \mu s$$
$$T_{COFF} = (\text{Temp} - 25°C)(0.02\ \mu s/°C)$$
$$(85°C - 25°C)(0.02\ \mu s/°C)$$
$$1.2\ \mu s$$

Temperature coefficient is only required for temperatures > 25°C. Below 25°C, T_{COFF} = 0 ms.

$$T_C = -(C_{HOLD})(R_{IC} + R_{SS} + R_S) \ln(1/2048)\ \mu s$$
$$-(25\ pF)\ (1\ k\Omega + 2\ k\Omega + 2.5\ k\Omega) \ln(0.0004883)\ \mu s$$
$$1.05\ \mu s$$

$$T_{ACQ} = 0.2\ \mu s + 1\ \mu s + 1.2\ \mu s$$
$$2.4\ \mu s$$

2.2 Selecting and Configuring Automatic Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/DONE bit is set.

When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit. This occurs when the ACQT<2:0> bits (ADCON2<5:3>) remain in their Reset state ('000') and is compatible with devices that do not offer programmable acquisition times.

If desired, the ACQT bits can be set to select a programmable acquisition time for the A/D module. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

2.3 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 11 TAD per 12-bit conversion. The source of the A/D conversion clock is software selectable.

There are seven possible options for TAD:

- 2 TOSC
- 4 TOSC
- 8 TOSC
- 16 TOSC
- 32 TOSC
- 64 TOSC
- Internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible but greater than the minimum TAD.

Table 2-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 2-1: TAD VS. DEVICE OPERATING FREQUENCIES

AD Clock Source (TAD)		Maximum Device Frequency
Operation	ADCS<2:0>	
2 TOSC	000	2.86 MHz
4 TOSC	100	5.71 MHz
8 TOSC	001	11.43 MHz
16 TOSC	101	22.86 MHz
32 TOSC	010	40.0 MHz
64 TOSC	110	40.0 MHz
RC(2)	x11	1.00 MHz(1)

Note 1: The RC source has a typical TAD time of 4 μs.

2: For device frequencies above 1 MHz, the device must be in Sleep mode for the entire conversion or the A/D accuracy may be out of specification.

2.4 Configuring Analog Port Pins

The ADCON1, TRISA, TRISF and TRISH registers control the operation of the A/D port pins. The port pins needed as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS<3:0> bits and the TRIS bits.

Note 1: When reading the PORT register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will be accurately converted.

2: Analog levels on any pin defined as a digital input may cause the digital input buffer to consume current out of the device's specification limits.

2.5 A/D Conversions

Figure 2-3 shows the operation of the A/D converter after the GO/DONE bit has been set and the ACQT<2:0> bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 2-4 shows the operation of the A/D converter after the GO/DONE bit has been set; the ACQT<2:0> bits are set to '010' and a 4 TAD acquisition time is selected before the conversion starts.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 TAD wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

Note: The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

2.6 Use of the CCP2 Trigger

An A/D conversion can be started by the "Special Event Trigger" of the CCP2 module. This requires that the CCP2M<3:0> bits (CCP2CON<3:0>) be programmed as '1011' and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D acquisition and conversion, and the Timer1 (or Timer3) counter will be reset to zero. Timer1 (or Timer3) is reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH:ADRESL to the desired location). The appropriate analog input channel must be selected and the minimum acquisition period is either timed by the user, or an appropriate TACQ time is selected before the Special Event Trigger sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), the Special Event Trigger will be ignored by the A/D module but will still reset the Timer1 (or Timer3) counter.

FIGURE 2-3: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)

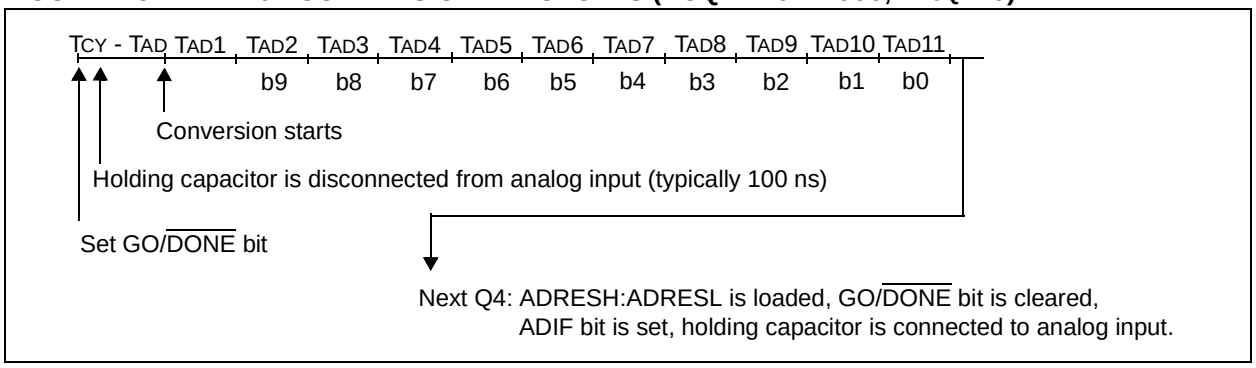
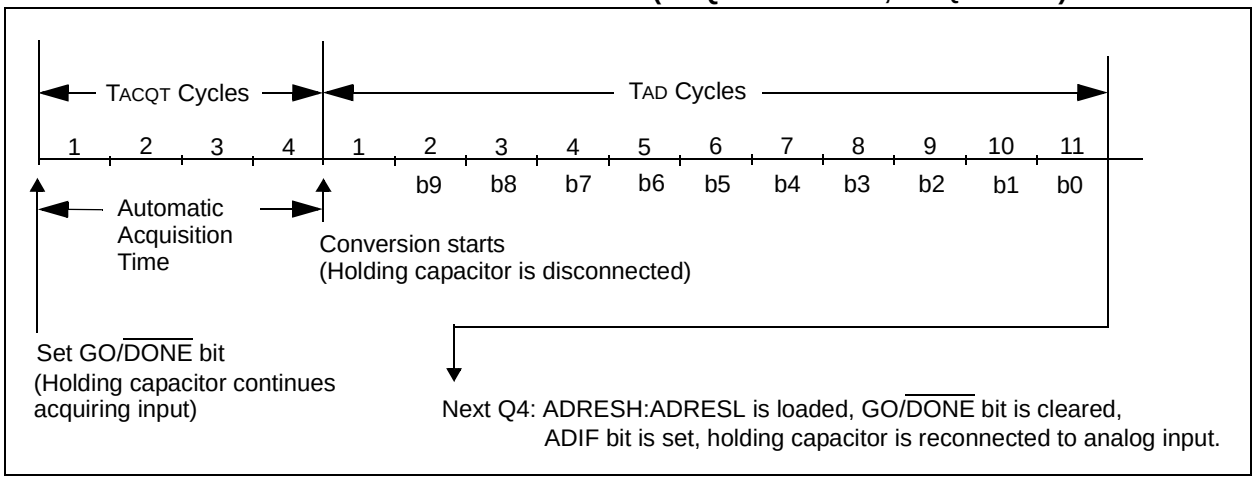


FIGURE 2-4: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)



2.7 A/D Converter Calibration

The A/D converter in the PIC18F87J93 family of devices includes a self-calibration feature which compensates for any offset generated within the module. The calibration process is automated and is initiated by setting the ADCAL bit (ADCON0<7>). The next time the GO/DONE bit is set, the module will perform a "dummy" conversion (which means it is reading none of the input channels) and store the resulting value internally to compensate for offset. Thus, subsequent offsets will be compensated.

The calibration process assumes that the device is in a relatively steady-state operating condition. If A/D calibration is used, it should be performed after each device Reset or if there are other major changes in operating conditions.

2.8 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT<2:0> and ADCS<2:0> bits in ADCON2 should be updated in accordance with the power-managed mode clock that will be used. After the power-managed mode is entered (either of the power-managed Run modes), an A/D acquisition or conversion may be started. Once an acquisition or conversion is started, the device should continue to be clocked by the same power-managed mode clock source until the conversion has been completed. If desired, the device may be placed into the corresponding power-managed Idle mode during the conversion.

If the power-managed mode clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in Sleep mode requires the A/D RC clock to be selected. If bits, ACQT<2:0>, are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry to Sleep mode. The IDLEN and SCSx bits in the OSCCON register must have already been cleared prior to starting the conversion.

TABLE 2-2: SUMMARY OF A/D REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Notes
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	**2**
PIR1	—	ADIF	RC1IF	TX1IF	SSPIF	—	TMR2IF	TMR1IF	**2**
PIE1	—	ADIE	RC1IE	TX1IE	SSPIE	—	TMR2IE	TMR1IE	**2**
IPR1	—	ADIP	RC1IP	TX1IP	SSPIP	—	TMR2IP	TMR1IP	**2**
PIR3	—	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	**2**
PIE3	—	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	**2**
IPR3	—	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	**2**
ADRESH	A/D Result Register High Byte								**2**
ADRESL	A/D Result Register Low Byte								**2**
ADCON0	ADCAL	—	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	**2**
ADCON1	TRIGSEL	—	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	**2**
ADCON2	ADFM	—	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	**2**
CCP2CON	—	—	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	**2**
PORTA	RA7(1)	RA6(1)	RA5	RA4	RA3	RA2	RA1	RA0	**2**
TRISA	TRISA7(1)	TRISA6(1)	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	**2**
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	—	**2**
TRISF	TRISF5	TRISF4	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	—	**2**

Legend: — = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

2: For these Reset values, see **Section 4.0 "Reset"** of the *"PIC18F87J90 Family Data Sheet"* (DS39933).

NOTES:

3.0 SPECIAL FEATURES OF THE CPU

Note 1: This section documents only the CPU features that are different from, or in addition to, the features of the PIC18F87J90 family devices.

2: For additional details on the Configuration bits, refer to **Section 24.1 "Configuration Bits"** in the *"PIC18F87J90 Family Data Sheet"* (DS39933).

3.1 Device ID Registers

The Device ID registers are "read-only" registers. They identify the device type and revision for device programmers and can be read by firmware using table reads.

TABLE 3-1: DEVICE ID REGISTERS

File Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value(1)
3FFFFEh	DEVID1	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	xxxx xxxx(2)
3FFFFFh	DEVID2	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	0000 10x1(2)

Legend: x = unknown, – = unimplemented. Shaded cells are unimplemented, read as '0'.

Note 1: Values reflect the unprogrammed state as received from the factory and following Power-on Resets. In all other Reset states, the configuration bytes maintain their previously programmed states.

2: See Register 3-1 and Register 3-2 for DEVID values. These registers are read-only and cannot be programmed by the user.

REGISTER 3-1: DEVID1: DEVICE ID REGISTER 1 FOR PIC18F87J93 FAMILY DEVICES

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

Legend:
R = Read-only bit

bit 7-5 **DEV<2:0>:** Device ID bits

111 = PIC18F87J93
110 = PIC18F86J93
011 = PIC18F67J93
010 = PIC18F66J93

bit 4-0 **REV<4:0>:** Revision ID bits

These bits are used to indicate the device revision.

REGISTER 3-2: DEVID2: DEVICE ID REGISTER 2 FOR PIC18F87J93 FAMILY DEVICES

R	R	R	R	R	R	R	R
DEV10(1)	DEV9(1)	DEV8(1)	DEV7(1)	DEV6(1)	DEV5(1)	DEV4(1)	DEV3(1)
bit 7							bit 0

Legend:
R = Read-only bit

bit 7-0 **DEV<10:3>:** Device ID bits(1)

These bits are used with the DEV<2:0> bits in the Device ID Register 1 to identify the part number.

0101 0000 = PIC18F87J93 family devices

Note 1: The values for DEV<10:3> may be shared with other device families. The specific device is always identified by using the entire DEV<10:0> bit sequence.

4.0 ELECTRICAL CHARACTERISTICS

Note: Other than some basic data, this section documents only the PIC18F87J93 family devices' specifications that differ from those of the PIC18F87J90 family devices. For detailed information on the electrical specifications shared by the PIC18F87J93 family and PIC18F87J90 family devices, see the *"PIC18F87J90 Family Data Sheet"* (DS39933).

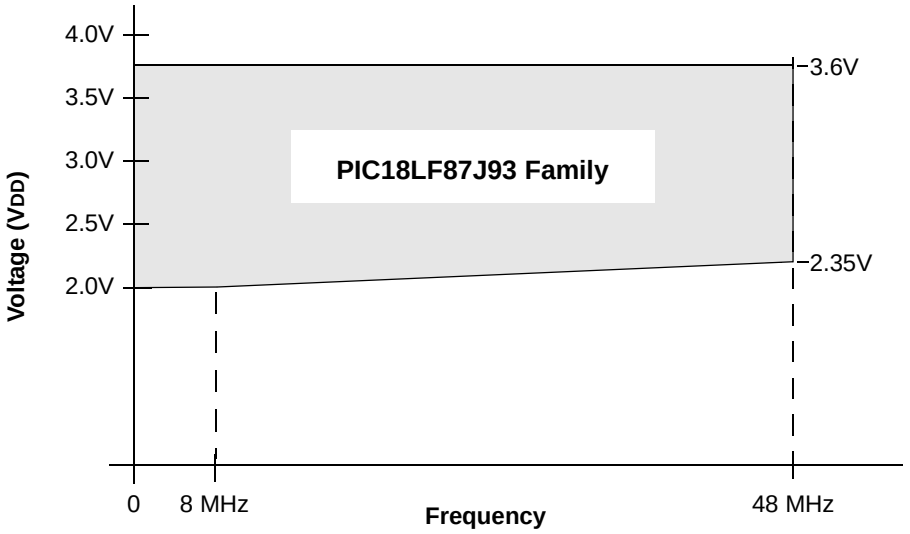
Absolute Maximum Ratings(†)

Ambient temperature under bias ..... -40°C to +100°C
Storage temperature ..... -65°C to +150°C
Voltage on any digital only I/O pin or $\overline{MCLR}$ with respect to V_{SS} (except V_{DD}) ..... -0.3V to 6.0V
Voltage on any combined digital and analog pin with respect to V_{SS} (except V_{DD} and $\overline{MCLR}$) ..... -0.3V to (V_{DD} + 0.3V)
Voltage on V_{DDCORE} with respect to V_{SS} ..... -0.3V to 2.75V
Voltage on V_{DD} with respect to V_{SS} ..... -0.3V to 3.6V
Total power dissipation **(Note 1)** 1.0W
Maximum current out of V_{SS} pin ..... 300 mA
Maximum current into V_{DD} pin ..... 250 mA
Maximum output current sunk by PORTA<7:6> and any PORTB and PORTC I/O pins ..... 25 mA
Maximum output current sunk by any PORTD, PORTE and PORTJ I/O pins ..... 8 mA
Maximum output current sunk by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins ..... 2 mA
Maximum output current sourced by PORTA<7:6> and any PORTB and PORTC I/O pins ..... 25 mA
Maximum output current sourced by any PORTD, PORTE and PORTJ I/O pins ..... 8 mA
Maximum output current sourced by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins ..... 2 mA
Maximum current sunk by all ports combined ..... 200 mA

Note 1: Power dissipation is calculated as follows:
$P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum(V_{OL} \times I_{OL})$

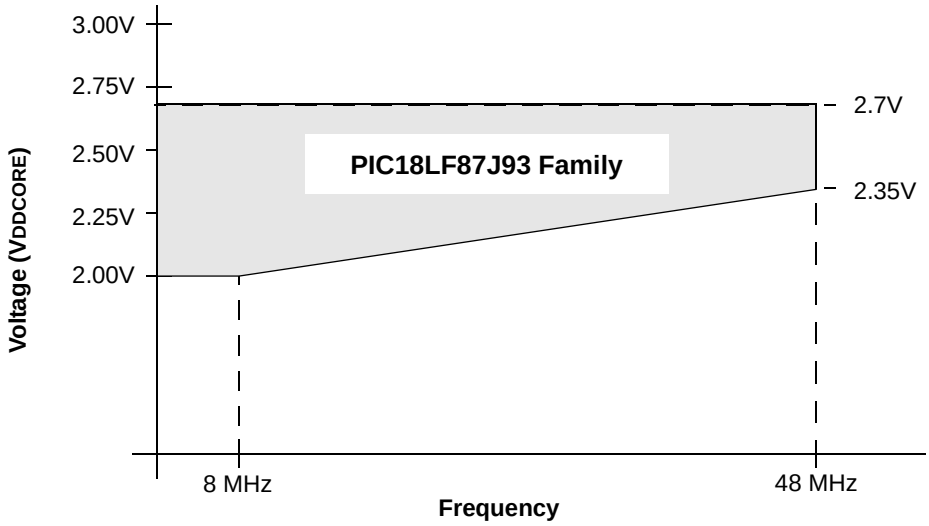
† **NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

FIGURE 4-1: VOLTAGE-FREQUENCY GRAPH, REGULATOR ENABLED (INDUSTRIAL)(1)



Note 1: When the on-chip regulator is enabled, its BOR circuit will automatically trigger a device Reset before VDD reaches a level at which full-speed operation is not possible.

FIGURE 4-2: VOLTAGE-FREQUENCY GRAPH, REGULATOR DISABLED (INDUSTRIAL)(1)



Note 1: When the on-chip voltage regulator is disabled, VDD and VDDCORE must be maintained so that VDDCORE ≤ VDD ≤ 3.6V.

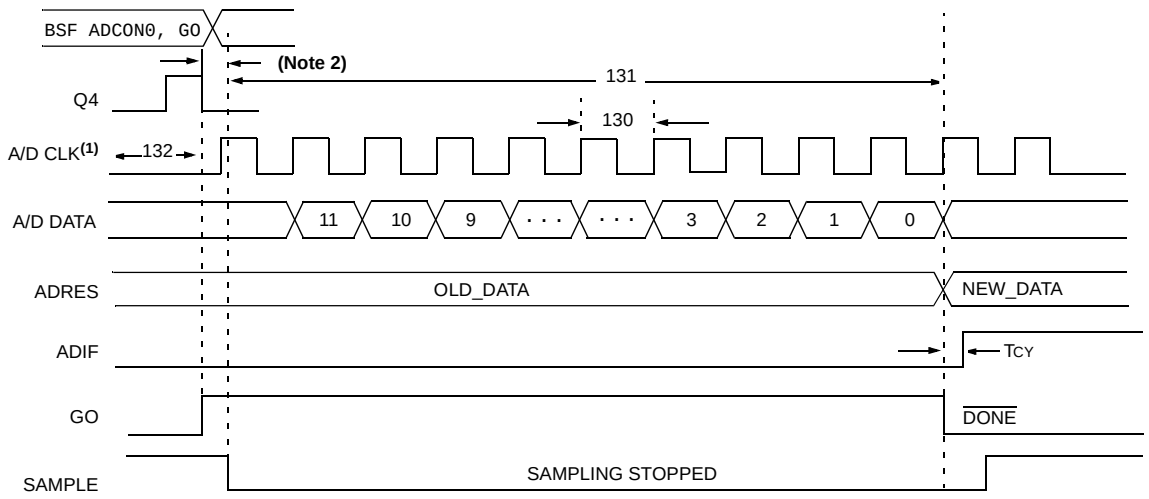
TABLE 4-1: A/D CONVERTER CHARACTERISTICS: PIC18F87J93 FAMILY (INDUSTRIAL)

Param No.	Sym	Characteristic	Min	Typ	Max	Units	Conditions
A01	NR	Resolution	—	—	12	bit	ΔVREF ≥ 3.0V
A03	EIL	Integral Linearity Error	—	<±1	±2.0	LSB	ΔVREF ≥ 3.0V
A04	EDL	Differential Linearity Error	—	<±1	±1.5	LSB	ΔVREF ≥ 3.0V
A06	EOFF	Offset Error	—	<±1	±5	LSB	ΔVREF ≥ 3.0V
A07	EGN	Gain Error	—	<±1	±3	LSB	ΔVREF ≥ 3.0V
A10	—	Monotonicity	Guaranteed(1)			—	VSS ≤ VAIN ≤ VREF
A20	ΔVREF	Reference Voltage Range (VREFH – VREFL)	3	—	VDD – VSS	V	For 12-bit resolution
A21	VREFH	Reference Voltage High	VSS + 3.0V	—	VDD + 0.3V	V	For 12-bit resolution
A22	VREFL	Reference Voltage Low	VSS – 0.3V	—	VDD – 3.0V	V	For 12-bit resolution
A25	VAIN	Analog Input Voltage	VREFL	—	VREFH	V	**Note 2**
A30	ZAIN	Recommended Impedance of Analog Voltage Source	—	—	2.5	kΩ	
A50	IREF	VREF Input Current(2)	— —	— —	5 150	μA μA	During VAIN acquisition. During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

2: VREFH current is from the RA3/AN3/VREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from the RA2/AN2/VREF-/CVREF pin or VSS, whichever is selected as the VREFL source.

FIGURE 4-3: A/D CONVERSION TIMING



Note 1: If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

2: This is a minimal RC delay (typically 100 ns), which also disconnects the holding capacitor from the analog input.

TABLE 4-2: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
130	TAD	A/D Clock Period	0.8	12.5(1)	µs	TOSC based, VREF ≥ 3.0V
131	TCNV	Conversion Time (not including acquisition time)(2)	13	14	TAD	
132	TACQ	Acquisition Time(3)	1.4	—	µs	
135	TSWC	Switching Time from Convert → Sample	—	**(Note 4)**		
137	TDIS	Discharge Time	0.2	—	µs	

Note 1: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES registers may be read on the following TCY cycle.

3: The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to VSS or VSS to VDD). The source impedance (RS) on the input channels is 50Ω.

4: On the following cycle of the device clock.

5.0 PACKAGING INFORMATION

For packaging information, see the *"PIC18F87J93 Family Data Sheet"* (DS39933).

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (June 2009)

Original data sheet for PIC18F87J93 family devices.

APPENDIX B: DEVICE DIFFERENCES

The differences between the devices listed in this data sheet are shown in Table B-1.

TABLE B-1: PIC18F87J93 FAMILY DEVICE DIFFERENCES

Features	PIC18F66J93	PIC18F67J93	PIC18F86J93	PIC18F87J93
Program Memory (Bytes)	64K	128K	64K	128K
Program Memory (Instructions)	32768	65536	32768	65536
Interrupt Sources	28	28	29	29
I/O Ports	Ports A, B, C, D, E, F, G	Ports A, B, C, D, E, F, G	Ports A, B, C, D, E, F, G, H, J	Ports A, B, C, D, E, F, G, H, J
Capture/Compare/PWM Modules	2	2	2	2
Enhanced Capture/Compare/PWM Modules	3	3	3	3
Packages	64-Pin TQFP	64-Pin TQFP	80-Pin TQFP	80-Pin TQFP

APPENDIX C: CONVERSION CONSIDERATIONS

This appendix discusses the considerations for converting from previous versions of a device to the ones listed in this data sheet. Typically, these changes are due to the differences in the process technology used. An example of this type of conversion is from a PIC16C74A to a PIC16C74B.

Not Applicable

APPENDIX D: MIGRATION FROM BASELINE TO ENHANCED DEVICES

This section discusses how to migrate from a Baseline device (such as the PIC16C5X) to an Enhanced MCU device (such as the PIC18FXXX).

The following are the list of modifications over the PIC16C5X microcontroller family:

Not Currently Available

INDEX

R

S

T

V

W

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Device: PIC18F87J93 Family Literature Number: DS39948A

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PRODUCT IDENTIFICATION SYSTEM

To order or obtain purchasing information such as pricing or delivery, refer to the factory or the listed sales office.

PART NO.	X	/XX	XXX
Device	Temperature Range	Package	Pattern

Device[1,2]	PIC18F66J93, PIC18F66J93T PIC18F67J93, PIC18F67J93T PIC18F86J93, PIC18F86J93T PIC18F87J93, PIC18F87J93T
Temperature Range	I = -40°C to +85°C (Industrial)
Package	PT = TQFP (Thin Quad Flatpack)
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)

Examples:

a) PIC18F87J93-I/PT 301 = Industrial temperature, TQFP package, QTP pattern #301.

b) PIC18F87J93T-I/PT = Tape and reel, Industrial temperature, TQFP package.

Note 1: F = Standard Voltage Range
2: T = In Tape and Reel

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